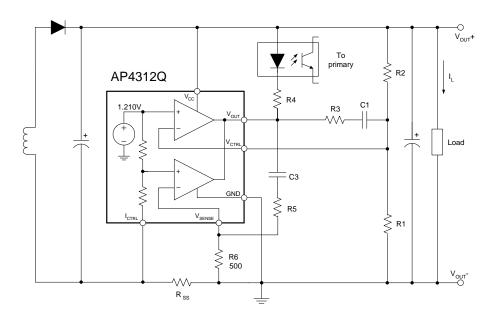


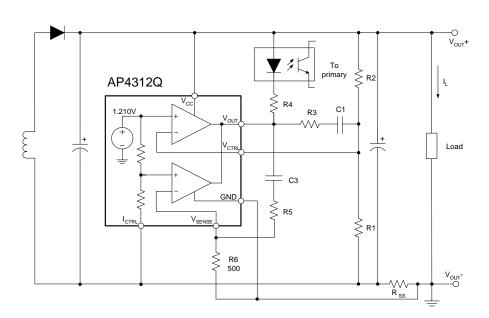
## **Typical Applications Circuit**



$$V_{OUT} = V_{REF} \times \frac{R1 + R2}{R1}$$

$$CurrentLimit = \frac{V_{SENSE}}{R_{SS}}$$

Typical Application 1



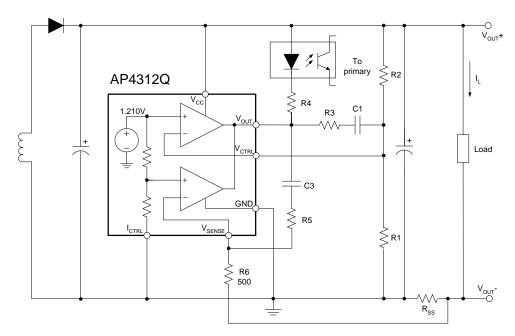
$$V_{OUT} = [V_{REF} + (I_L \times R_{SS})] \times \frac{R1 + R2}{R1} - (I_L \times R_{SS})$$

$$CurrentLimit = \frac{V_{SENSE}}{R_{SS}}$$

Typical Application 2



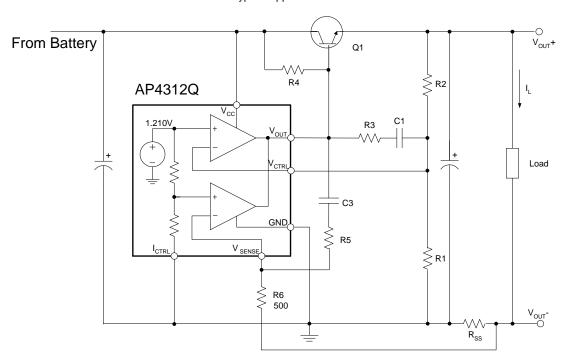
## **Typical Applications Circuit (Cont.)**



$$V_{OUT} = V_{REF} \times \frac{R1 + R2}{R1} - (I_L \times R_{SS})$$

$$CurrentLimit = \frac{V_{SENSE} \times V_{REF}}{\left(V_{SENSE} + V_{REF}\right) \times R_{SS}}$$

#### **Typical Application 3**



Typical Application 4

$$V_{OUT} = V_{REF} \times \frac{R1 + R2}{R1} - (I_L \times R_{SS})$$

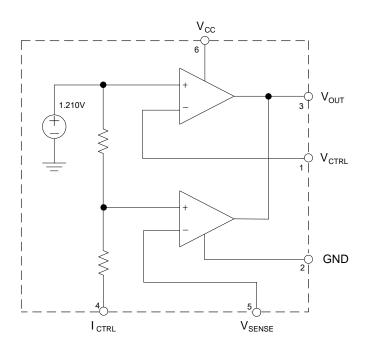
$$CurrentLimit = \frac{V_{SENSE} \times V_{REF}}{\left(V_{SENSE} + V_{REF}\right) \times R_{SS}}$$



## **Pin Descriptions**

Pin Number	Pin Name	Function	
1	V <sub>CTRL</sub>	Input pin of the voltage control loop	
2	GND	Ground	
3	V <sub>OUT</sub>	Output pin. Sinking current only	
4	I <sub>CTRL</sub>	Input pin of the current control loop	
5	V <sub>SENSE</sub>	Input pin of the current control loop	
6	V <sub>cc</sub>	Power Supply	

# **Functional Block Diagram**



# Absolute Maximum Ratings (Note 4)

Symbol	Parameter	Rating	Unit
V <sub>CC</sub>	Power Supply Voltage	20	V
$V_{IN}$	Input Voltage	-0.3 to V <sub>CC</sub>	V
$T_J$	Junction Temperature	+150	°C
$T_{STG}$	Storage Temperature	-65 to +150	°C
$T_{LEAD}$	Lead Temperature (Soldering, 5sec)	+260	°C
$\theta_{JA}$	Thermal Resistance (Junction to Ambient)	250	°C/W



Note 4: Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.

## **Recommended Operating Conditions**

Symbol	Parameter	Min	Max	Unit
V <sub>CC</sub>	Power Supply Voltage	1.7	18	V

## $\textbf{Electrical Characteristics} \ (@V_{CC}=5V, T_A=+25^{\circ}C, unless \ otherwise \ specified.)$

Symbol	Parameters	Conditions	Min	Тур	Max	Unit	
TOTAL CURREN	TOTAL CURRENT CONSUMPTION						
	Total Supply Current Not Including the	T <sub>A</sub> =+25°C	_	180	_	- μΑ	
I <sub>cc</sub>	Output Sinking Current	-40°C <t<sub>A&lt;+105°C</t<sub>	_	_	300		
VOLTAGE CONT	ROL LOOP						
	Transconductance of Voltage Control	T <sub>A</sub> =+25°C	1	3.5	-	mA/mV	
Gmv	Loop Op-Amp (Sink Current Only)	-40°C <t<sub>A&lt;+105°C</t<sub>	-	2.5	-		
V		T <sub>A</sub> =+25°C	1.204	1.21	1.216	V	
$V_{REF}$	Voltage Control Loop Reference	-40°C <t<sub>A&lt;+105°C</t<sub>	1.186		1.234		
	Input Bias Current (V <sub>CTRL</sub> )	T <sub>A</sub> =+25°C	-	50	-	nA	
I <sub>IBV</sub>		-40°C <t<sub>A&lt;+105°C</t<sub>	_	100	_ n/	IIA	
CURRENT CONT	ROL LOOP						
0 :	Transconductance of Current Control	T <sub>A</sub> =+25°C	1.5	7	-	A () (	
Gmi	Loop Op-Amp (Sink Current Only)	-40°C <t<sub>A&lt;+105°C</t<sub>	1.5	7	_	mA/mV	
.,		T <sub>A</sub> =+25°C	67.9	70	72.1	- mV	
$V_{SENSE}$	Current Control Loop Reference	-40°C <t<sub>A&lt;+105°C</t<sub>	66		74		
	2	T <sub>A</sub> =+25°C	_	18	-	μА	
I <sub>IBI</sub>	Current Out of Pin I <sub>CTRL</sub> at V <sub>SENSE</sub>	-40°C <t<sub>A&lt;+105°C</t<sub>	-	35	-		
OUTPUT STAGE	OUTPUT STAGE						
V	Low Output Voltage Level	T <sub>A</sub> =+25°C, I <sub>SINK</sub> =2mA	-	100	-	mV	
V <sub>OL</sub>		-40°C <t<sub>A&lt;+105°C, I<sub>SINK</sub>=2mA</t<sub>	-	100	-		
-	Output Short Circuit Current.	T <sub>A</sub> =+25°C	-	27	50	50 _ mA	
l <sub>os</sub>	Output to V <sub>CC</sub> . Sink Current Only	-40°C <t<sub>A&lt;+105°C</t<sub>	-	35	_		

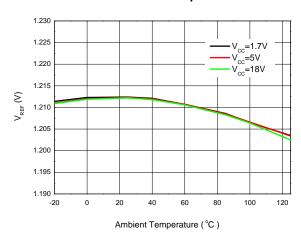
## **Thermal Impedance**

Symbol	Parameter	Value	Unit	
θ <sub>JC</sub>	Thermal Resistance (Junction to Case)	84	°C/W	

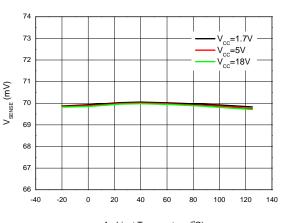


### **Performance Characteristics**

#### **Voltage Control Loop Reference** vs. Ambient Temperature

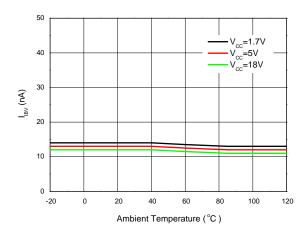


## **Current Control Loop Reference** vs. Ambient Temperature

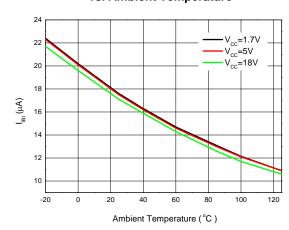


Ambient Temperature (°C)

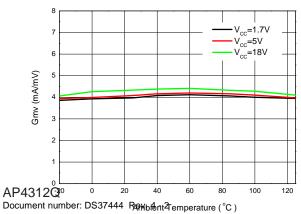
#### Input Bias Current (VCTRL) vs. Ambient Temperature



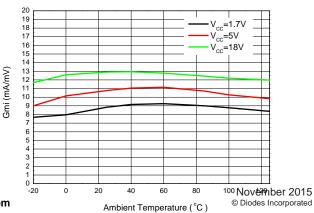
#### Current Out of Pin ICTRL at VSENSE vs. Ambient Temperature



### **Transconductance of Voltage Control Loop Op-Amp vs. Ambient Temperature**



#### **Transconductance of Current Control Loop Op-Amp vs. Ambient Temperature**



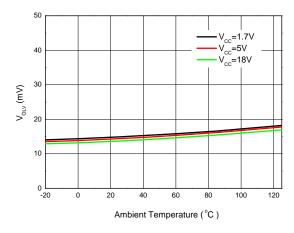
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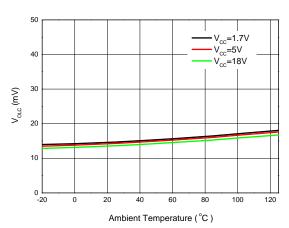


#### **Performance Characteristics (Cont.)**

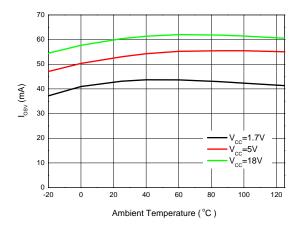
#### Low Output Level of Voltage Control Loop Op-Amp vs. Ambient Temperature



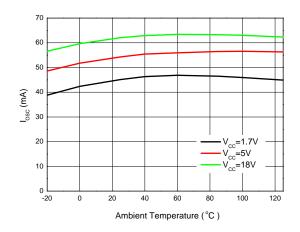
#### Low Output Level of Current Control Loop Op-Amp vs. Ambient Temperature



# Output Short Circuit Current of Voltage Control Loop Op-Amp vs. Ambient Temperature

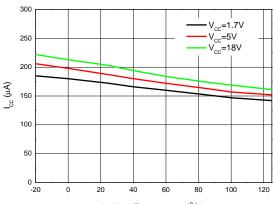


Output Short Circuit Current of Current Control Loop Op-Amp vs. Ambient Temperature



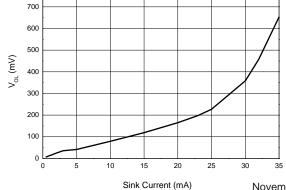
Low Output Voltage Level vs. Sink Current

#### Total Supply Current Not Including the Output Sinking Current vs. Ambient Temperature



## AP4312Q Ambient Temperature (°C)

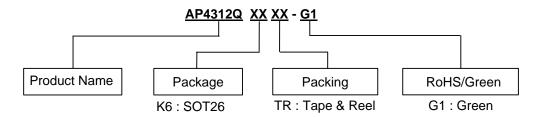
Document number: DS37444 Rev. 4 - 2



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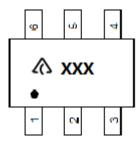
## **Ordering Information**



Package	Part Number	Marking ID	Packing	
SOT26	AP4312QK6TR-G1	GKD	3000/Tape & Reel	

## **Marking Information**

#### (Top View)



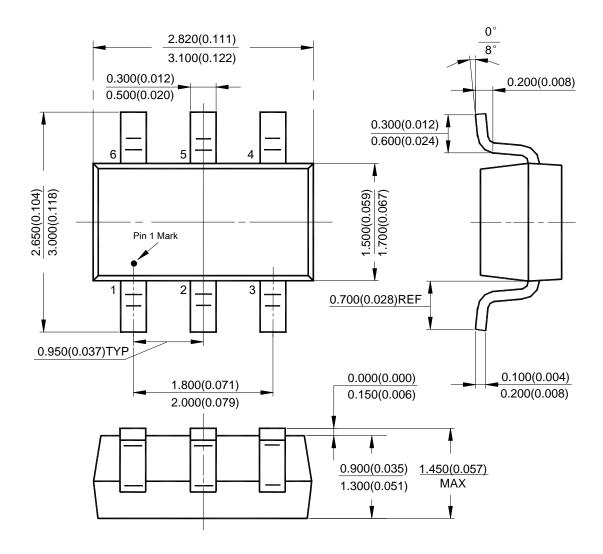
A: Logo

XXX: Marking ID (See Ordering Information)



## Package Outline Dimensions (All dimensions in mm(inch).)

#### (1) Package Type: SOT26

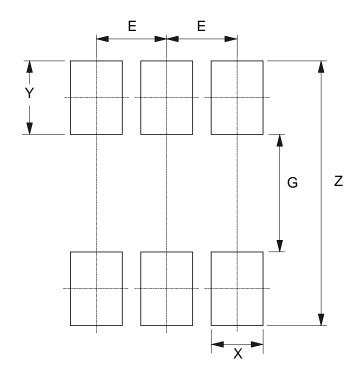


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## **Suggested Pad Layout**

(1) Package Type: SOT26



Dimensions	Z	G	X	Y	E
	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)
Value	3.600/0.142	1.600/0.063	0.700/0.028	1.000/0.039	0.950/0.037



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